

RESIN COMPOSITION AND CROSSLINKED MICROPARTICLE DISPERSED CURABLE RESIN COMPOSITION

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- European:

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Abstract of JP 2000178398 (A)

PROBLEM TO BE SOLVED: To provide a curable resin composition capable of simultaneously satisfying the three performances of low viscosity, low shrinkage, and rapid curability. **SOLUTION:** This composition is prepared by dispersing (A) crosslinked microparticles obtained by polymerizing (a) a radical-polymerizable ethylenically unsaturated compound and (b) a compound having at least three (meth)acryloyl groups in the molecule and having a mean primary particle diameter in the range of 10-1,000 nm in (B) a compound having at least one (meth)acryloyl group on the molecule.

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